

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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#### **Features**

- High current operation for greater luminous output
- Low power consumption and thermal resistance
- Can be used with automatic insertion equipment
- RoHS Compliant





## Benefits:

- •Rugged design allows for easy maintenance
- •Robust package for optimum reliability

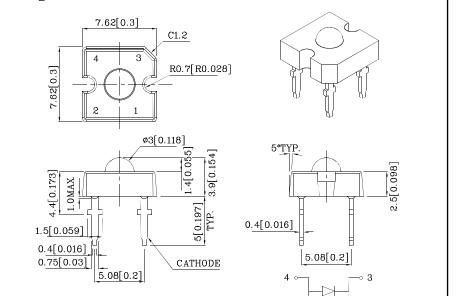
## **Typical Applications:**

- •Automotive side markers
- •Gaming and entertainment lighting
- •Signs and road hazard indicators



#### ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES

## **Package Schematics**



#### Notes:

1. All dimensions are in millimeters (inches).

 $(T_A=25^{\circ}C)$ 

- 2. Tolerance is  $\pm 0.25(0.01")$  unless otherwise noted.
- 3. Specifications are subject to change without notice.

**Operating Characteristics** 

Forward Voltage (Min.) (I<sub>F</sub>=70mA)

Forward Voltage (Typ.) (I<sub>F</sub>=70mA)

Forward Voltage (Max.) (I<sub>F</sub>=70mA)

Reverse Current (Max.) (V<sub>R</sub>=5V)

Wavelength of Peak Emission

CIE127-2007\*(Typ.) (I<sub>F</sub>=70mA) Wavelength of Dominant Emission

CIE127-2007\*(Typ.) (I<sub>F</sub>=70mA) Spectral Line Full Width At Half

Capacitance (Typ.) (V<sub>F</sub>=0V, f=1MHz)

Maximum (Typ.) (I<sub>F</sub>=70mA)

Thermal Resistance (Typ.)

Absolute Maximum Rating (T <sub>A</sub> =25°C)	Red (AlGaInP)	Unit		
Reverse Voltage	$V_{R}$	5	V	
DC Forward Current	$I_{\mathrm{F}}$	70	mA	
Power Dissipation	ation P <sub>D</sub>		mW	
Operating Temperature	$T_{\rm A}$	-40 ~ +8 <b>5</b>	°C	
Storage Temperature	Tstg	-55 ~ +85		
Lead Solder Temperature [1.5mm Below Seating Plane.]	260°C For 5 Seconds			

Reverse Voltage	$V_{R}$	5	V			
DC Forward Current	$I_{\mathrm{F}}$	70	mA			
Power Dissipation	PD	210	mW			
Operating Temperature	$T_{\mathrm{A}}$	-40 ~ +8 <b>5</b>	°C			
Storage Temperature	Tstg	-55 ~ +85	30			
Lead Solder Temperature [1.5mm Below Seating Plane.	260°C For 5 Seconds					
- 11 D (II )						

1.No Reflow soldering.

2.A Relative Humidity between 40% and 60% is recommended in

ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

Part Number	Emitting Color	Emitting Material	Lens-color	CIE12'	s Intensity 7-2007* mA) cd	Luminous Flux CIE127-2007* (I <sub>F</sub> =70mA) lm	Wavelength CIE127-2007* λP nm	Viewing Angle 20 1/2
				min.	typ.	typ.		
XSM2CRK983W	Red	AlGaInP	Water Clear	5.5 2.7*	8.99 4.49*	6.3*	640*	70°

- 1.Luminous intensity is measured with an integrating sphere after the device has stabilized.
- 2.0 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- 3.LEDs are binned according to their Luminous intensity.
- \* Luminous intensity / luminous flux value and wavelength are in accordance with CIE127-2007 standards.

Red

(AlGaInP)

2.0

2.4

3.0

10

640\*

625\*

20

27

125

 $V_{\rm F}$ 

 $V_{\rm F}$ 

 $V_{\rm F}$ 

 $I_R$ 

 $\lambda P$ 

 $\lambda D$ 

 $\triangle \lambda$ 

 $\mathbf{C}$ 

Rθj-pin

Unit

V

V

V

uA

nm

nm

nm

pF

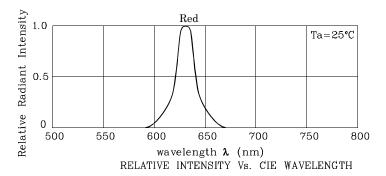
°C/W



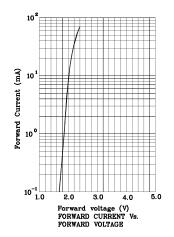


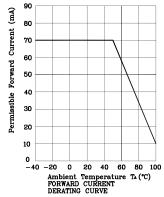


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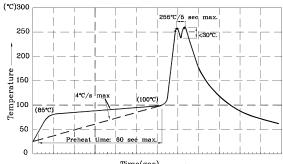


### ❖ Red



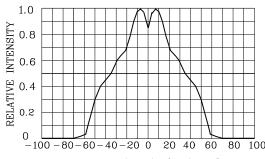


Wave Soldering Profile For Thru-Hole Products (Pb-Free Components)

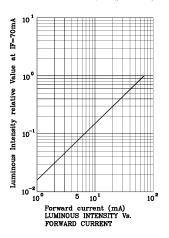


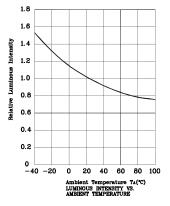
- 1.Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260°C 2.Peak wave soldering temperature between 245°C ~ 255°C for 3 sec

- (5 sec max). 3.Do not apply stress to the epoxy resin while the temperature is above 85°C. 4. Fixtures should not incur stress on the component when mounting and during soldering process.
  5.SAC 305 solder alloy is recommended.
  6. No more than one wave soldering pass.



OFF AXIS ANGLE(DEGREES) RELATIVE INTENSITY VS OFF AXIS ANGLE





#### Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity / luminous flux, or wavelength),

the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous Intensity / Luminous Flux: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

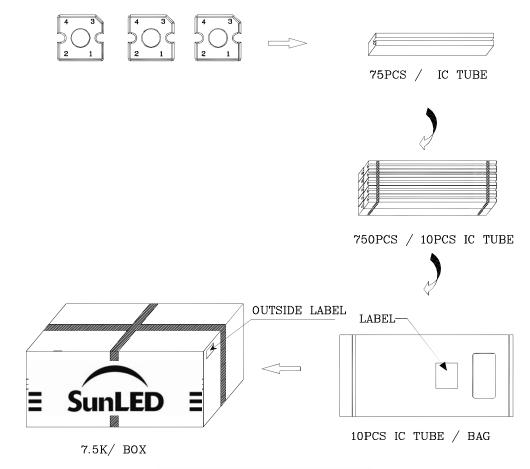


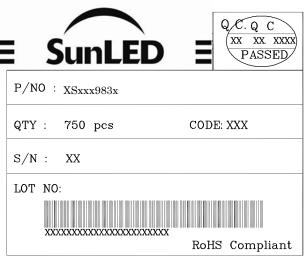




## PACKING & LABEL SPECIFICATIONS

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- $6. \ Additional\ technical\ notes\ are\ available\ at\ \underline{http://www.SunLEDusa.com/TechnicalNotes.asp}$

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